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Ki-deok BAE and Yong-seop YOON	SAMSUNG ELECTRONICS CO., LTD. 416, Maetan-dong, Paldal-gu, Suwon-city, Kyungki-do, Republic of Korea	
Additional name(s) of conveying party(ies) attached?		
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Execution Date: October 9, 2001	□ yes ☑ no	
4. Application number(s) or patent number(s):		
If this document is being filed together with a new application, the execution date of the application is: October 9, 2001		
A. Patent Application No.(s)/Confirmation No.(s)	B. Patent No.(s)	
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5. Name and address of party to whom correspondence concerning document should be mailed:	6. Total number of applications and registration involved:	
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ASSIGNMENT

Whereas, I/We, 1) Ki-deok Bae, and 2) Yong-seop Yoon of 1) 103-1103 Dongsung 2-cha Apt., 1003-8 Suji-eub, Yongin-city, Kyungki-do, Rep. of Korea, and 2) 102-504 Donga Apt., 66-3 Chamwondong, Seocho-gu, Seoul, Rep. of Korea

hereinafter called assignor(s), have invented certain improvements in METHOD OF FABRICATING ANTI-STICTION MICROMACHINED STRUCTURES

and executed an application for Letters Patent of the United States of America therefor on

_____9 . October 2001; and

Whereas, SAMSUNG ELECTRONICS CO., LTD. of 416, Maetan-dong, Paldal-gu, Suwonacity, Kyungki-do, Republic of Korea (assignee), desires to acquire the entire right, title and interest in the application and invention, and to any United States patents to be obtained therefor;

Now therefore, for valuable consideration, receipt whereof is hereby acknowledged.

I/We the above-named assignor(s), hereby sell, assign and transfer to the above named assignee, its successors and assigns, the entire right, title and interest in the application and the invention disclosed therein for the United States of America, including the right to claim priority under 35 U.S.C. § 119, and I/we request the Commissioner of Patents to issue any Letters Patent granted upon the invention set forth in the application to the assignee, its successors and assigns; and I/we will execute without further consideration all papers deemed necessary by the assignee in connection with the United States application when called upon to do so by the assignee.

(Legalization not required for recording but is prima facie evidence of execution under 35 U.S.C. § 261) 8/92

PATENT
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